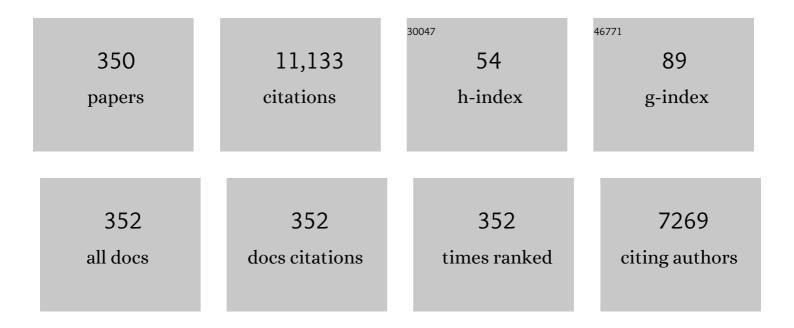
Martin Kuball

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/8650672/publications.pdf Version: 2024-02-01



MADTIN KURALI

| # | Article | IF | CITATIONS |
|----|---|-----|-----------|
| 1 | The 2018 GaN power electronics roadmap. Journal Physics D: Applied Physics, 2018, 51, 163001. | 1.3 | 843 |
| 2 | Raman spectroscopy of GaN, AlGaN and AlN for process and growth monitoring/control. Surface and Interface Analysis, 2001, 31, 987-999. | 0.8 | 327 |
| 3 | Measurement of temperature in active high-power AlGaN/GaN HFETs using Raman spectroscopy. IEEE Electron Device Letters, 2002, 23, 7-9. | 2.2 | 295 |
| 4 | Buffer Design to Minimize Current Collapse in GaN/AlGaN HFETs. IEEE Transactions on Electron Devices, 2012, 59, 3327-3333. | 1.6 | 271 |
| 5 | Thermal Boundary Resistance Between GaN and Substrate in AlGaN/GaN Electronic Devices. IEEE Transactions on Electron Devices, 2007, 54, 3152-3158. | 1.6 | 231 |
| 6 | Integrated micro-Raman/infrared thermography probe for monitoring of self-heating in AlGaN/GaN transistor structures. IEEE Transactions on Electron Devices, 2006, 53, 2438-2447. | 1.6 | 212 |
| 7 | A study of the phase diagram of (K,Na,Li)NbO3 determined by dielectric and piezoelectric measurements, and Raman spectroscopy. Journal of Applied Physics, 2007, 102, . | 1.1 | 175 |
| 8 | "Leaky Dielectric―Model for the Suppression of Dynamic \$R_{mathrm{ON}}\$ in Carbon-Doped AlGaN/GaN HEMTs. IEEE Transactions on Electron Devices, 2017, 64, 2826-2834. | 1.6 | 170 |
| 9 | Measurement of temperature distribution in multifinger AlGaN/GaN heterostructure field-effect transistors using micro-Raman spectroscopy. Applied Physics Letters, 2003, 82, 124-126. | 1.5 | 163 |
| 10 | Benchmarking of Thermal Boundary Resistance in AlGaN/GaN HEMTs on SiC Substrates: Implications of the Nucleation Layer Microstructure. IEEE Electron Device Letters, 2010, 31, 1395-1397. | 2.2 | 150 |
| 11 | Low thermal resistance GaN-on-diamond transistors characterized by three-dimensional Raman thermography mapping. Applied Physics Letters, 2014, 104, 083513. | 1.5 | 133 |
| 12 | Modulating the thermal conductivity in hexagonal boron nitride via controlled boron isotope concentration. Communications Physics, 2019, 2, . | 2.0 | 129 |
| 13 | Raman scattering studies on single-crystalline bulk AlN under high pressures. Applied Physics Letters, 2001, 78, 724-726. | 1.5 | 127 |
| 14 | Reducing GaN-on-diamond interfacial thermal resistance for high power transistor applications. Applied Physics Letters, 2015, 106, . | 1.5 | 126 |
| 15 | Self-heating effects at high pump currents in deep ultraviolet light-emitting diodes at 324 nm. Applied Physics Letters, 2002, 81, 3491-3493. | 1.5 | 124 |
| 16 | Integrated Optical and Electrical Analysis: Identifying Location and Properties of Traps in AlGaN/GaN HEMTs During Electrical Stress. IEEE Electron Device Letters, 2010, 31, 662-664. | 2.2 | 120 |
| 17 | Time-Resolved Temperature Measurement of AlGaN/GaN Electronic Devices Using Micro-Raman Spectroscopy. IEEE Electron Device Letters, 2007, 28, 86-89. | 2.2 | 114 |
| 18 | Recombination dynamics in InGaN quantum wells. Applied Physics Letters, 1996, 69, 4194-4196. | 1.5 | 112 |

| # | Article | IF | CITATIONS |
|----|---|-----|-----------|
| 19 | Iron-induced deep-level acceptor center in GaN/AlGaN high electron mobility transistors: Energy level and cross section. Applied Physics Letters, 2013, 102, . | 1.5 | 111 |
| 20 | Channel Temperature Determination in High-Power AlGaN/GaN HFETs Using Electrical Methods and Raman Spectroscopy. IEEE Transactions on Electron Devices, 2008, 55, 478-482. | 1.6 | 109 |
| 21 | Intentionally Carbon-Doped AlGaN/GaN HEMTs: Necessity for Vertical Leakage Paths. IEEE Electron Device Letters, 2014, 35, 327-329. | 2.2 | 108 |
| 22 | Low Thermal Boundary Resistance Interfaces for GaN-on-Diamond Devices. ACS Applied Materials & Interfaces, 2018, 10, 24302-24309. | 4.0 | 98 |
| 23 | Raman spectroscopy of (K,Na)NbO3 and (K,Na)1â^'xLixNbO3. Applied Physics Letters, 2008, 93, . | 1.5 | 97 |
| 24 | Control of the in-plane thermal conductivity of ultra-thin nanocrystalline diamond films through the grain and grain boundary properties. Acta Materialia, 2016, 103, 141-152. | 3.8 | 97 |
| 25 | Barrier-Layer Optimization for Enhanced GaN-on-Diamond Device Cooling. ACS Applied Materials & Interfaces, 2017, 9, 34416-34422. | 4.0 | 91 |
| 26 | Thermal characterization of polycrystalline diamond thin film heat spreaders grown on GaN HEMTs. Applied Physics Letters, 2017, 111, . | 1.5 | 90 |
| 27 | Piezoelectric strain in AlGaNâ^•GaN heterostructure field-effect transistors under bias. Applied Physics Letters, 2006, 88, 103502. | 1.5 | 88 |
| 28 | Optical pump-and-probe measurement of the thermal conductivity of nitride thin films. Journal of Applied Physics, 2002, 92, 3820-3824. | 1.1 | 87 |
| 29 | Buffer transport mechanisms in intentionally carbon doped GaN heterojunction field effect transistors. Applied Physics Letters, 2014, 104, . | 1.5 | 87 |
| 30 | Phonon lifetimes in bulk AlN and their temperature dependence. Applied Physics Letters, 2000, 77, 1958-1960. | 1.5 | 86 |
| 31 | A Review of Raman Thermography for Electronic and Opto-Electronic Device Measurement With Submicron Spatial and Nanosecond Temporal Resolution. IEEE Transactions on Device and Materials Reliability, 2016, 16, 667-684. | 1.5 | 85 |
| 32 | Micro-Raman Temperature Measurements for Electric Field Assessment in Active AlGaN–GaN HFETs. IEEE Electron Device Letters, 2004, 25, 456-458. | 2.2 | 79 |
| 33 | Thermal stability of GaN investigated by Raman scattering. Applied Physics Letters, 1998, 73, 960-962. | 1.5 | 78 |
| 34 | Influence of threading dislocation density on early degradation in AlGaN/GaN high electron mobility transistors. Applied Physics Letters, 2011, 99, 223501. | 1.5 | 77 |
| 35 | Phonon lifetimes and phonon decay in InN. Applied Physics Letters, 2005, 86, 223501. | 1.5 | 75 |
| 36 | Bulk AlN crystal growth: self-seeding and seeding on 6H-SiC substrates. Journal of Crystal Growth, 2002, 246, 187-193. | 0.7 | 73 |

| # | Article | IF | CITATIONS |
|----|--|-----|-----------|
| 37 | Influence of the interface composition of InAs/AISb superlattices on their optical and structural properties. Journal of Applied Physics, 1995, 77, 811-820. | 1.1 | 72 |
| 38 | Timeâ€resolved pumpâ€probe experiments with subwavelength lateral resolution. Applied Physics Letters, 1996, 69, 2465-2467. | 1.5 | 69 |
| 39 | Nitrogen-rich indium nitride. Journal of Applied Physics, 2004, 95, 6124-6128. | 1.1 | 68 |
| 40 | Deformation potentials of the E2(high) phonon mode of AlN. Applied Physics Letters, 2002, 81, 1426-1428. | 1.5 | 67 |
| 41 | Ferroelectric domains and piezoelectricity in monocrystalline Pb(Zr,Ti)O3 nanowires. Applied Physics Letters, 2007, 90, 133107. | 1.5 | 67 |
| 42 | AlGaN/GaN HEMT device reliability and degradation evolution: Importance of diffusion processes. Microelectronics Reliability, 2011, 51, 195-200. | 0.9 | 67 |
| 43 | Improved Thermal Performance of AlGaN/GaN HEMTs by an Optimized Flip-Chip Design. IEEE Transactions on Electron Devices, 2006, 53, 2696-2702. | 1.6 | 64 |
| 44 | Temperature Dependence of the Phonons of Bulk AlN. Japanese Journal of Applied Physics, 2000, 39, L710-L712. | 0.8 | 63 |
| 45 | Gain characteristics of InGaN/GaN quantum well diode lasers. Applied Physics Letters, 1998, 72, 1418-1420. | 1.5 | 62 |
| 46 | GaN nanoindentation: A micro-Raman spectroscopy study of local strain fields. Journal of Applied Physics, 2004, 96, 2853-2856. | 1.1 | 62 |
| 47 | Lattice dynamics of wurtzite and rocksalt AlN under high pressure: Effect of compression on the crystal anisotropy of wurtzite-type semiconductors. Physical Review B, 2008, 77, . | 1.1 | 61 |
| 48 | Electric Field Reduction in C-Doped AlGaN/GaN on Si High Electron Mobility Transistors. IEEE Electron Device Letters, 2015, 36, 826-828. | 2.2 | 61 |
| 49 | Gain spectroscopy on InGaN/GaN quantum well diodes. Applied Physics Letters, 1997, 70, 2580-2582. | 1.5 | 60 |
| 50 | Simultaneous determination of the lattice thermal conductivity and grain/grain thermal resistance in polycrystalline diamond. Acta Materialia, 2017, 139, 215-225. | 3.8 | 60 |
| 51 | Reducing Thermal Resistance of AlGaN/GaN Electronic Devices Using Novel Nucleation Layers. IEEE Electron Device Letters, 2009, 30, 103-106. | 2.2 | 59 |
| 52 | Near-field optical study of InGaN/GaN epitaxial layers and quantum wells. Applied Physics Letters, 1998, 72, 2645-2647. | 1.5 | 58 |
| 53 | Simultaneous measurement of temperature and thermal stress in AlGaN/GaN high electron mobility transistors using Raman scattering spectroscopy. Journal of Applied Physics, 2009, 106, . | 1.1 | 58 |
| 54 | Microâ€Raman scattering spectroscopy study of Liâ€doped and undoped ZnO needle crystals. Journal of Raman Spectroscopy, 2009, 40, 556-561. | 1.2 | 57 |

| # | Article | IF | CITATIONS |
|----|--|-----|-----------|
| 55 | Terahertz oscillations in an In0.53Ga0.47As submicron planar Gunn diode. Journal of Applied Physics, 2014, 115, . | 1.1 | 56 |
| 56 | Temperature-Dependent Thermal Resistance of GaN-on-Diamond HEMT Wafers. IEEE Electron Device Letters, 2016, 37, 621-624. | 2.2 | 56 |
| 57 | Pulsed Large Signal RF Performance of Field-Plated Ga ₂ O ₃ MOSFETs. IEEE Electron Device Letters, 2018, 39, 1572-1575. | 2.2 | 55 |
| 58 | On the link between electroluminescence, gate current leakage, and surface defects in AlGaN/GaN high electron mobility transistors upon off-state stress. Applied Physics Letters, 2012, 101, . | 1.5 | 54 |
| 59 | Raman Thermography of Peak Channel Temperature in <inline-formula> <tex-math notation="LaTeX">\$eta\$ </tex-math> </inline-formula>-Ga²O³ MOSFETs. IEEE Electron Device Letters, 2019, 40, 189-192.</tex-math </inline-formula> | 2.2 | 54 |
| 60 | Raman scattering studies on single-crystalline bulk AlN: temperature and pressure dependence of the AlN phonon modes. Journal of Crystal Growth, 2001, 231, 391-396. | 0.7 | 51 |
| 61 | Raman characterization and stress analysis of AlN grown on SiC by sublimation. Journal of Applied Physics, 2002, 92, 5183-5188. | 1.1 | 51 |
| 62 | Thermal Properties of AlGaN/GaN HFETs on Bulk GaN Substrates. IEEE Electron Device Letters, 2012, 33, 366-368. | 2.2 | 48 |
| 63 | Operating channel temperature in GaN HEMTs: DC versus RF accelerated life testing. Microelectronics Reliability, 2015, 55, 2505-2510. | 0.9 | 47 |
| 64 | Angular dispersion of polar phonons in a hexagonal GaN–AlN superlattice. Materials Science and Engineering B: Solid-State Materials for Advanced Technology, 2001, 82, 27-29. | 1.7 | 46 |
| 65 | Thick, Adherent Diamond Films on AlN with Low Thermal Barrier Resistance. ACS Applied Materials & Interfaces, 2019, 11, 40826-40834. | 4.0 | 45 |
| 66 | Crystal growth and properties of scandium nitride. Journal of Materials Science: Materials in Electronics, 2004, 15, 555-559. | 1.1 | 44 |
| 67 | Leakage mechanisms in GaN-on-GaN vertical pn diodes. Applied Physics Letters, 2018, 112, . | 1.5 | 44 |
| 68 | Importance of impurity diffusion for early stage degradation in AlGaN/GaN high electron mobility transistors upon electrical stress. Applied Physics Letters, 2010, 97, 023503. | 1.5 | 43 |
| 69 | Contactless Thermal Boundary Resistance Measurement of GaN-on-Diamond Wafers. IEEE Electron Device Letters, 2014, 35, 1007-1009. | 2.2 | 43 |
| 70 | Impact of diamond seeding on the microstructural properties and thermal stability of GaN-on-diamond wafers for high-power electronic devices. Scripta Materialia, 2017, 128, 57-60. | 2.6 | 43 |
| 71 | Electrical and Thermal Performance of AlGaN/GaN HEMTs on Diamond Substrate for RF Applications. , 2013, , . | | 42 |
| 72 | Record-Low Thermal Boundary Resistance between Diamond and GaN-on-SiC for Enabling Radiofrequency Device Cooling. ACS Applied Materials & Interfaces, 2021, 13, 60553-60560. | 4.0 | 42 |

| # | Article | IF | CITATIONS |
|----|---|-----|-----------|
| 73 | InN Thin Film Lattice Dynamics by Grazing Incidence Inelastic X-Ray Scattering. Physical Review Letters, 2011, 106, 205501. | 2.9 | 41 |
| 74 | \$hbox{In}_{0.53}hbox{Ga}_{0.47}hbox{As}\$ Planar Gunn Diodes Operating at a Fundamental Frequency of 164 GHz. IEEE Electron Device Letters, 2013, 34, 39-41. | 2.2 | 41 |
| 75 | Effect of grain size of polycrystalline diamond on its heat spreading properties. Applied Physics Express, 2016, 9, 061302. | 1.1 | 41 |
| 76 | High-temperature processing of GaN: The influence of the annealing ambient on strain in GaN. Applied Physics Letters, 1999, 75, 2097-2099. | 1.5 | 40 |
| 77 | Raman mapping of epitaxial lateral overgrown GaN: Stress at the coalescence boundary. Journal of Applied Physics, 2001, 90, 3656-3658. | 1.1 | 40 |
| 78 | Thermal conductivity of ultrathin nano-crystalline diamond films determined by Raman thermography assisted by silicon nanowires. Applied Physics Letters, 2015, 106, . | 1.5 | 40 |
| 79 | Mixed-size diamond seeding for low-thermal-barrier growth of CVD diamond onto GaN and AlN. Carbon, 2020, 167, 620-626. | 5.4 | 40 |
| 80 | Thermal conductivity of bulk GaN—Effects of oxygen, magnesium doping, and strain field compensation. Applied Physics Letters, 2014, 105, . | 1.5 | 39 |
| 81 | A Raman spectroscopy study of InN. Journal of Crystal Growth, 2004, 269, 59-65. | 0.7 | 38 |
| 82 | Nanosecond Timescale Thermal Dynamics of AlGaN/GaN Electronic Devices. IEEE Electron Device Letters, 2008, 29, 416-418. | 2.2 | 38 |
| 83 | Crystalline Interlayers for Reducing the Effective Thermal Boundary Resistance in GaN-on-Diamond. ACS Applied Materials & Interfaces, 2020, 12, 54138-54145. | 4.0 | 38 |
| 84 | Impact of Intrinsic Stress in Diamond Capping Layers on the Electrical Behavior of AlGaN/GaN HEMTs. IEEE Transactions on Electron Devices, 2013, 60, 3149-3156. | 1.6 | 37 |
| 85 | Localization of off-stress-induced damage in AlGaN/GaN high electron mobility transistors by means of low frequency 1/f noise measurements. Applied Physics Letters, 2013, 103, . | 1.5 | 37 |
| 86 | Hot-Electron-Related Degradation in InAlN/GaN High-Electron-Mobility Transistors. IEEE Transactions on Electron Devices, 2014, 61, 2793-2801. | 1.6 | 37 |
| 87 | "Kink―in AlGaN/GaN-HEMTs: Floating Buffer Model. IEEE Transactions on Electron Devices, 2018, 65, 3746-3753. | 1.6 | 37 |
| 88 | Atomic layer deposited <i>α</i> -Ga ₂ O ₃ solar-blind photodetectors. Journal Physics D: Applied Physics, 2019, 52, 475101. | 1.3 | 35 |
| 89 | Thermal mapping of defects in AlGaNâ^•GaN heterostructure field-effect transistors using micro-Raman spectroscopy. Applied Physics Letters, 2005, 87, 103508. | 1.5 | 34 |
| 90 | Achieving the Best Thermal Performance for GaN-on-Diamond. , 2013, , . | | 34 |

| # | Article | IF | CITATIONS |
|-----|--|-----|-----------|
| 91 | Damage tolerance of nuclear graphite at elevated temperatures. Nature Communications, 2017, 8, 15942. | 5.8 | 34 |
| 92 | High-pressure high-temperature annealing of ion-implanted GaN films monitored by visible and ultraviolet micro-Raman scattering. Journal of Applied Physics, 2000, 87, 2736-2741. | 1.1 | 33 |
| 93 | Surface Zeta Potential and Diamond Seeding on Gallium Nitride Films. ACS Omega, 2017, 2, 7275-7280. | 1.6 | 33 |
| 94 | Evidence for impact ionisation in AlGaN/GaN HEMTs with InGaN back-barrier. Electronics Letters, 2011, 47, 405. | 0.5 | 32 |
| 95 | Influence of buffer layer and 6H-SiC substrate polarity on the nucleation of AlN grown by the sublimation sandwich technique. Journal of Crystal Growth, 2001, 233, 177-186. | 0.7 | 31 |
| 96 | Substrate-directed formation of calcium carbonate fibres. Journal of Materials Chemistry, 2009, 19, 387-398. | 6.7 | 31 |
| 97 | Optical investigation of degradation mechanisms in AlGaN/GaN high electron mobility transistors: Generation of non-radiative recombination centers. Applied Physics Letters, 2012, 100, . | 1.5 | 31 |
| 98 | Lateral Charge Transport in the Carbon-Doped Buffer in AlGaN/GaN-on-Si HEMTs. IEEE Transactions on Electron Devices, 2017, 64, 977-983. | 1.6 | 31 |
| 99 | Insights into electroluminescent emission from AlGaNâ^•GaN field effect transistors using micro-Raman thermal analysis. Applied Physics Letters, 2006, 88, 023507. | 1.5 | 30 |
| 100 | Annealing effect of surface-activated bonded diamond/Si interface. Diamond and Related Materials, 2019, 93, 187-192. | 1.8 | 30 |
| 101 | Microscopic structure of the GaAs(001)-(6×6) surface derived from scanning tunneling microscopy. Physical Review B, 1995, 51, 13880-13882. | 1.1 | 29 |
| 102 | Inelastic Light Scattering by Phonons in Hexagonal GaN-AlN Nanostructures. Physica Status Solidi A, 2001, 183, 157-161. | 1.7 | 29 |
| 103 | Optical investigation of micrometer and nanometer-size individual GaN pillars fabricated by reactive ion etching. Journal of Applied Physics, 2002, 91, 6520. | 1.1 | 29 |
| 104 | Charge movement in a GaN-based hetero-structure field effect transistor structure with carbon doped buffer under applied substrate bias. Journal of Applied Physics, 2015, 118, . | 1.1 | 29 |
| 105 | Low thermal resistance of a GaN-on-SiC transistor structure with improved structural properties at the interface. Journal of Crystal Growth, 2015, 428, 54-58. | 0.7 | 29 |
| 106 | Transient Thermoreflectance for Gate Temperature Assessment in Pulse Operated GaN-Based HEMTs. IEEE Electron Device Letters, 2016, 37, 1197-1200. | 2.2 | 29 |
| 107 | Buffer-Induced Current Collapse in GaN HEMTs on Highly Resistive Si Substrates. IEEE Electron Device Letters, 2018, 39, 1556-1559. | 2.2 | 29 |
| 108 | The effects of grain size and grain boundary characteristics on the thermal conductivity of nanocrystalline diamond. Journal of Applied Physics, 2016, 119, . | 1.1 | 28 |

| # | Article | IF | CITATIONS |
|-----|--|-----|-----------|
| 109 | Control of Buffer-Induced Current Collapse in AlGaN/GaN HEMTs Using SiN _x Deposition. IEEE Transactions on Electron Devices, 2017, 64, 4044-4049. | 1.6 | 28 |
| 110 | Determination of the Self-Compensation Ratio of Carbon in AlGaN for HEMTs. IEEE Transactions on Electron Devices, 2018, 65, 1838-1842. | 1.6 | 28 |
| 111 | Amorphous GaN Grown by Room Temperature Molecular Beam Epitaxy. Japanese Journal of Applied Physics, 2000, 39, 4753-4754. | 0.8 | 27 |
| 112 | Raman scattering and photoluminescence studies on Si/SiO2 superlattices. Journal of Applied Physics, 2001, 89, 7903-7907. | 1.1 | 27 |
| 113 | Raman mapping, photoluminescence investigations, and finite element analysis of epitaxial lateral overgrown GaN on silicon substrates. Applied Physics Letters, 2002, 80, 2275-2277. | 1.5 | 27 |
| 114 | Diamond micro-Raman thermometers for accurate gate temperature measurements. Applied Physics Letters, 2014, 104, . | 1.5 | 27 |
| 115 | A macro-scale ruck and tuck mechanism for deformation in ion-irradiated polycrystalline graphite. Carbon, 2021, 173, 215-231. | 5.4 | 27 |
| 116 | Crystal growth of B12As2 on SiC substrate by CVD method. Journal of Crystal Growth, 2005, 273, 431-438. | 0.7 | 26 |
| 117 | Temperature analysis of AlGaN/GaN based devices using photoluminescence spectroscopy: Challenges and comparison to Raman thermography. Journal of Applied Physics, 2010, 107, . | 1.1 | 26 |
| 118 | Time-dependent thermal crosstalk in multifinger AlGaN/GaN HEMTs and implications on their electrical performance. Solid-State Electronics, 2011, 57, 14-18. | 0.8 | 26 |
| 119 | Impact of carbon in the buffer on power switching GaN-on-Si and RF GaN-on-SiC HEMTs. Japanese Journal of Applied Physics, 2021, 60, SB0802. | 0.8 | 26 |
| 120 | Vibrational and optical properties of GaN nanowires synthesized by Ni-assisted catalytic growth. Nanotechnology, 2007, 18, 445704. | 1.3 | 25 |
| 121 | (Invited) Intrinsic Reliability Assessment of 650V Rated AlGaN/GaN Based Power Devices: An Industry Perspective. ECS Transactions, 2016, 72, 65-76. | 0.3 | 25 |
| 122 | Above bandgap thermoreflectance for non-invasive thermal characterization of GaN-based wafers. Applied Physics Letters, 2018, 113, . | 1.5 | 25 |
| 123 | Nano-Fabrication of GaN Pillars Using Focused Ion Beam Etching. Physica Status Solidi A, 1999, 176, 355-358. | 1.7 | 24 |
| 124 | Resonant Raman scattering on self-assembled GaN quantum dots. Applied Physics Letters, 2001, 78, 987-989. | 1.5 | 24 |
| 125 | Evidence for phonon-plasmon interaction inInNby Raman spectroscopy. Physical Review B, 2007, 75, . | 1.1 | 24 |
| 126 | GaN-on-diamond electronic device reliability: Mechanical and thermo-mechanical integrity. Applied Physics Letters, 2015, 107, . | 1.5 | 24 |

| # | Article | IF | CITATIONS |
|-----|--|------------------|----------------------------|
| 127 | Impact of Silicon Nitride Stoichiometry on the Effectiveness of AlGaN/GaN HEMT Field Plates. IEEE Transactions on Electron Devices, 2017, 64, 1197-1202. | 1.6 | 24 |
| 128 | Degradation of AlGaN during high-temperature annealing monitored by ultraviolet Raman scattering. Applied Physics Letters, 1999, 74, 549-551. | 1.5 | 23 |
| 129 | High-Resolution Raman Temperature Measurements in GaAs p-HEMT Multifinger Devices. IEEE Transactions on Electron Devices, 2007, 54, 1838-1842. | 1.6 | 23 |
| 130 | Temperature assessment of AlGaN/GaN HEMTs: A comparative study by Raman, electrical and IR thermography. , 2010, , . | | 23 |
| 131 | High spatial resolution micro-Raman temperature measurements of nitride devices (FETs and light) Tj ETQq1 1 0. | 784314 rg 0.8 | gBT_/Overlock |
| 132 | Energy band structure and optical response function of icosahedral <mml:math xmlns:mml="http://www.w3.org/1998/Math/MathML" display="inline"><mml:mrow><mml:msub><mml:mtext>B</mml:mtext><mml:mrow><mml:mn>12</mml:mn><!--<br-->A spectroscopic ellipsometry and first-principles calculational study. Physical Review B, 2010, 81, .</mml:mrow></mml:msub></mml:mrow></mml:math | mmi:mrov | w> <mark>??</mark> mml:msu |
| 133 | Quantifying Temperature-Dependent Substrate Loss in GaN-on-Si RF Technology. IEEE Transactions on Electron Devices, 2019, 66, 1681-1687. | 1.6 | 22 |
| 134 | Reliability of AlGaN/GaN high electron mobility transistors on low dislocation density bulk GaN substrate: Implications of surface step edges. Applied Physics Letters, 2013, 103, 193507. | 1.5 | 21 |
| 135 | Interface State Artefact in Long Gate-Length AlGaN/GaN HEMTs. IEEE Transactions on Electron Devices, 2015, 62, 2464-2469. | 1.6 | 21 |
| 136 | Hexagonal Boron Nitride Single Crystal Growth from Solution with a Temperature Gradient. Chemistry of Materials, 2020, 32, 5066-5072. | 3.2 | 21 |
| 137 | Thermal boundary resistance of direct van der Waals bonded GaN-on-diamond. Semiconductor Science and Technology, 2020, 35, 095021. | 1.0 | 21 |
| 138 | GaN-on-diamond technology platform: Bonding-free membrane manufacturing process. AIP Advances, 2020, 10, . | 0.6 | 21 |
| 139 | Doping dependence of theE1andE1+Δ1critical points in highly dopedn- andp-type GaAs: Importance of surface band bending and depletion. Physical Review B, 1994, 49, 16569-16574. | 1.1 | 20 |
| 140 | Investigation of polarization-pinning mechanism in deep-line-etched vertical-cavity surface-emitting lasers. Applied Physics Letters, 2000, 76, 400-402. | 1.5 | 20 |
| 141 | Design and performance analysis of deep-etch air/nitride distributed Bragg reflector gratings for AlInGaN laser diodes. Applied Physics Letters, 2001, 79, 4076-4078. | 1.5 | 20 |
| 142 | Direct signature of strained GaN quantum dots by Raman scattering. Applied Physics Letters, 2001, 79, 686-688. | 1.5 | 20 |
| 143 | Three-dimensional thermal analysis of a flip-chip mounted AlGaN/GaN HFET using confocal micro-Raman spectroscopy. IEEE Transactions on Electron Devices, 2006, 53, 2658-2661. | 1.6 | 20 |
| 144 | Current collapse in AlGaN/GaN transistors studied using time-resolved Raman thermography. Applied Physics Letters, 2008, 93, 203510. | 1.5 | 20 |

| # | Article | IF | CITATIONS |
|-----|--|-----|-----------|
| 145 | Time evolution of off-state degradation of AlGaN/GaN high electron mobility transistors. Applied Physics Letters, 2014, 104, . | 1.5 | 20 |
| 146 | Mechanism of hot electron electroluminescence in GaN-based transistors. Journal Physics D: Applied Physics, 2016, 49, 435101. | 1.3 | 20 |
| 147 | Hydrogen adsorption on GaAs(110): A study of the surface optical properties. Physical Review B, 1994, 50, 8609-8615. | 1.1 | 19 |
| 148 | Photoluminescence spectroscopy on annealed molecular beam epitaxy grown GaN. Journal of Applied Physics, 2001, 89, 1070-1074. | 1.1 | 19 |
| 149 | Optical characterization of hierarchical ZnO structures grown with a simplified vapour transport method. Nanotechnology, 2007, 18, 215705. | 1.3 | 19 |
| 150 | Fabrication of GaN nanowalls and nanowires using surface charge lithography. Materials Letters, 2008, 62, 4576-4578. | 1.3 | 19 |
| 151 | The role of surface barrier oxidation on AlGaN/GaN HEMTs reliability. Microelectronics Reliability, 2012, 52, 29-32. | 0.9 | 19 |
| 152 | Low Field Vertical Charge Transport in the Channel and Buffer Layers of GaN-on-Si High Electron Mobility Transistors. IEEE Electron Device Letters, 2020, 41, 1754-1757. | 2.2 | 19 |
| 153 | The Impact of Hot Electrons and Self-Heating During Hard-Switching in AlGaN/GaN HEMTs. IEEE Transactions on Electron Devices, 2020, 67, 869-874. | 1.6 | 19 |
| 154 | Thermal stress modelling of diamond on GaN/III-Nitride membranes. Carbon, 2021, 174, 647-661. | 5.4 | 19 |
| 155 | Influence of hydrogen adsorption on the optical properties of the GaAs(100)-c(4×4) surface. Physical Review B, 1995, 51, 10923-10928. | 1.1 | 18 |
| 156 | Raman scattering in GaN pillar arrays. Journal of Applied Physics, 2002, 91, 2866-2869. | 1.1 | 18 |
| 157 | Sublimation crystal growth of yttrium nitride. Journal of Crystal Growth, 2010, 312, 2896-2903. | 0.7 | 18 |
| 158 | Dynamic Transconductance Dispersion Characterization of Channel Hot-Carrier Stressed 0.25- \$muhbox{m}\$ AlGaN/GaN HEMTs. IEEE Electron Device Letters, 2012, 33, 1550-1552. | 2.2 | 18 |
| 159 | Improved thermal management for GaN power electronics: Silver diamond composite packages. Microelectronics Reliability, 2012, 52, 3022-3025. | 0.9 | 18 |
| 160 | AlGaN/GaN field effect transistors for power electronics—Effect of finite GaN layer thickness on thermal characteristics. Applied Physics Letters, 2013, 103, . | 1.5 | 18 |
| 161 | Self-Heating Characterization of \$eta\$ -Ga ₂ O ₃ Thin-Channel MOSFETs by Pulsed \${I}\$ –\${V}\$ and Raman Nanothermography. IEEE Transactions on Electron Devices, 2020, 67, 204-211. | 1.6 | 18 |
| 162 | New Technique for Sublimation Growth of AlN Single Crystals. MRS Internet Journal of Nitride Semiconductor Research, 2001, 6, 1. | 1.0 | 17 |

| # | Article | IF | CITATIONS |
|-----|---|-----|-----------|
| 163 | Raman spectroscopy of B12As2 under high pressure. Journal of Applied Physics, 2004, 96, 910-912. | 1.1 | 17 |
| 164 | Photoluminescence and vibrational properties of nanostructured ZnSe templates. Semiconductor Science and Technology, 2007, 22, 1115-1121. | 1.0 | 17 |
| 165 | Electroluminescence of hot electrons in AlGaN/GaN high-electron-mobility transistors under radio frequency operation. Applied Physics Letters, 2015, 106, . | 1.5 | 17 |
| 166 | Glass-Glass Transitions by Means of an Acceptor-Donor Percolating Electric-Dipole Network. Physical Review Applied, 2017, 8, . | 1.5 | 17 |
| 167 | Finite element analysis of epitaxial lateral overgrown GaN: Voids at the coalescence boundary. Applied Physics Letters, 2001, 79, 4127-4129. | 1.5 | 16 |
| 168 | Phase selectivity of microwave heating evidenced by Raman spectroscopy. Journal of Applied Physics, 2006, 99, 113505. | 1.1 | 16 |
| 169 | Dynamic Operational Stress Measurement of MEMS Using Time-Resolved Raman Spectroscopy. Journal of Microelectromechanical Systems, 2008, 17, 1315-1321. | 1.7 | 16 |
| 170 | Laser lift-off transfer of AlGaN/GaN HEMTs from sapphire onto Si: A thermal perspective. Solid-State Electronics, 2009, 53, 526-529. | 0.8 | 16 |
| 171 | On the origin of dynamic Ron in commercial GaN-on-Si HEMTs. Microelectronics Reliability, 2018, 81, 306-311. | 0.9 | 16 |
| 172 | Nanosecond transient thermoreflectance method for characterizing anisotropic thermal conductivity. Review of Scientific Instruments, 2019, 90, 114903. | 0.6 | 16 |
| 173 | Thermal Design Rules of AlGaN/GaN-Based Microwave Transistors on Diamond. IEEE Transactions on Electron Devices, 2021, 68, 1530-1536. | 1.6 | 16 |
| 174 | The Durability of Various Crucible Materials for Aluminum Nitride Crystal Growth by Sublimation. MRS Internet Journal of Nitride Semiconductor Research, 2004, 9, 1. | 1.0 | 15 |
| 175 | Origin of kink effect in AlGaN/GaN high electron mobility transistors: Yellow luminescence and Fe doping. Applied Physics Letters, 2012, 101, . | 1.5 | 15 |
| 176 | Negative dynamic Ron in AlGaN/GaN power devices. , 2017, , . | | 15 |
| 177 | Passivation of Layered Gallium Telluride by Double Encapsulation with Graphene. ACS Omega, 2019, 4, 18002-18010. | 1.6 | 15 |
| 178 | Scanning thermal microscopy for accurate nanoscale device thermography. Nano Today, 2021, 39, 101206. | 6.2 | 15 |
| 179 | Raman spectroscopy of GaN, AlGaN and AlN for process and growth monitoring/control. , 2001, 31, 987. | | 15 |
| 180 | Micro-Raman Study of Wurtzite AlN Layers Grown on Si(111). Physica Status Solidi A, 2001, 188, 511-514. | 1.7 | 14 |

| # | Article | IF | CITATIONS |
|-----|---|-----|-----------|
| 181 | Free-standing GaN grown on epitaxial lateral overgrown GaN substrates. Journal of Crystal Growth, 2003, 255, 277-281. | 0.7 | 14 |
| 182 | Resonant Raman spectroscopy on InN. Physica Status Solidi (A) Applications and Materials Science, 2005, 202, 763-767. | 0.8 | 14 |
| 183 | Integrated Raman - IR Thermography on AlGaN/GaN Transistors. , 2006, , . | | 14 |
| 184 | Thermal Properties and Reliability of GaN Microelectronics: Sub-Micron Spatial and Nanosecond Time Resolution Thermography. , 2007, , . | | 14 |
| 185 | Demonstration of boron arsenide heterojunctions: A radiation hard wide band gap semiconductor device. Applied Physics Letters, 2010, 96, . | 1.5 | 14 |
| 186 | Reduction of Impact Ionization in GaAs-Based Planar Gunn Diodes by Anode Contact Design. IEEE Transactions on Electron Devices, 2012, 59, 654-660. | 1.6 | 14 |
| 187 | Bulk AlN crystal growth by direct heating of the source using microwaves. Journal of Crystal Growth, 2004, 262, 168-174. | 0.7 | 13 |
| 188 | Micro-Raman/Infrared Temperature Monitoring of Gunn Diodes. IEEE Transactions on Electron Devices, 2008, 55, 1090-1093. | 1.6 | 13 |
| 189 | Single-crystalline B12As2 on m-plane (11Â⁻00)â€^15R-SiC. Applied Physics Letters, 2008, 92, . | 1.5 | 13 |
| 190 | Thermal conductivity and Seebeck coefficients of icosahedral boron arsenide films on silicon carbide. Journal of Applied Physics, 2010, 108, 084906. | 1.1 | 13 |
| 191 | Semiconducting icosahedral boron arsenide crystal growth for neutron detection. Journal of Crystal Growth, 2011, 318, 553-557. | 0.7 | 13 |
| 192 | Non-Arrhenius Degradation of AlGaN/GaN HEMTs Grown on Bulk GaN Substrates. IEEE Electron Device Letters, 2012, 33, 1126-1128. | 2.2 | 13 |
| 193 | Influence of microstructural defects on the thermal conductivity of Ga <scp>N</scp> : A molecular dynamics study. Physica Status Solidi (B): Basic Research, 2013, 250, 1541-1545. | 0.7 | 13 |
| 194 | Progressive failure site generation in AlGaN/GaN high electron mobility transistors under OFF-state stress: Weibull statistics and temperature dependence. Applied Physics Letters, 2015, 106, . | 1.5 | 13 |
| 195 | Neutron Irradiation Impact on AlGaN/GaN HEMT Switching Transients. IEEE Transactions on Nuclear Science, 2018, 65, 2862-2869. | 1.2 | 13 |
| 196 | Characterization of the Interfacial Toughness in a Novel "GaN-on-Diamond―Material for High-Power RF Devices. ACS Applied Electronic Materials, 2019, 1, 354-369. | 2.0 | 13 |
| 197 | Submicrometer Resolution Hyperspectral Quantum Rod Thermal Imaging of Microelectronic Devices. ACS Applied Electronic Materials, 2020, 2, 93-102. | 2.0 | 13 |
| 198 | Variable range hopping mechanism and modeling of isolation leakage current in GaN-based high-electron-mobility transistors. Applied Physics Letters, 2020, 116, . | 1.5 | 13 |

| # | Article | IF | CITATIONS |
|-----|---|------|-----------|
| 199 | Electric field mapping of wide-bandgap semiconductor devices at a submicrometre resolution. Nature Electronics, 2021, 4, 478-485. | 13.1 | 13 |
| 200 | Hydrogen adsorption on the GaAs(001)-(2×4) surface: A scanning-tunneling-microscopy study. Physical Review B, 1995, 52, 16337-16340. | 1.1 | 12 |
| 201 | Electric-field-induced Raman scattering in GaAs: Franz-Keldysh oscillations. Physical Review B, 1995, 51, 7353-7356. | 1.1 | 12 |
| 202 | Raman Scattering in GaN/AlN Quantum Dot Structures. Physica Status Solidi (B): Basic Research, 1999, 216, 457-460. | 0.7 | 12 |
| 203 | On-line tools for microscopic and macroscopic monitoring of microwave processing. Physica B: Condensed Matter, 2007, 398, 191-195. | 1.3 | 12 |
| 204 | Electric field distribution in AlGaN/GaN high electron mobility transistors investigated by electroluminescence. Applied Physics Letters, 2010, 97, 033502. | 1.5 | 12 |
| 205 | Converse piezoelectric strain in undoped and Fe-doped AlGaN/GaN heterostructure field effect transistors studied by Raman scattering. Semiconductor Science and Technology, 2010, 25, 085004. | 1.0 | 12 |
| 206 | Impact ionisation electroluminescence in planar GaAs-based heterostructure Gunn diodes: Spatial distribution and impact of doping non-uniformities. Journal of Applied Physics, 2013, 113, 124505. | 1.1 | 12 |
| 207 | Measuring the thermal conductivity of the GaN buffer layer in AlGaN/GaN HEMTs. Physica Status Solidi (A) Applications and Materials Science, 2015, 212, 1742-1745. | 0.8 | 12 |
| 208 | Evaluation of Pulsed <i>I</i> – <i>V</i> Analysis as Validation Tool of Nonlinear RF Models of GaN-Based HFETs. IEEE Transactions on Electron Devices, 2018, 65, 5307-5313. | 1.6 | 12 |
| 209 | Isotopically Enhanced Thermal Conductivity in Few-Layer Hexagonal Boron Nitride: Implications for Thermal Management. ACS Applied Nano Materials, 2020, 3, 12148-12156. | 2.4 | 12 |
| 210 | Phonon deformation potentials of the E2(high) phonon mode of AlxGa1â^'xN. Applied Physics Letters, 2004, 85, 2217-2219. | 1.5 | 11 |
| 211 | Effect of pressure on the Raman scattering of wurtzite AlN. Physica Status Solidi (B): Basic Research, 2007, 244, 42-47. | 0.7 | 11 |
| 212 | Defect structures in B12As2 epitaxial layers grown on (0001) 6H-SiC. Journal of Applied Physics, 2008, 103, 123508. | 1.1 | 11 |
| 213 | Solvent dependent study of carbonyl vibrations of 3â€phenoxybenzaldehyde and 4â€ethoxybenzaldehyde by Raman spectroscopy and <i>ab initio</i> calculations. Journal of Raman Spectroscopy, 2009, 40, 921-935. | 1.2 | 11 |
| 214 | Implications of gate-edge electric field in AlGaN/GaN high electron mobility transistors during OFF-state degradation. Microelectronics Reliability, 2014, 54, 2650-2655. | 0.9 | 11 |
| 215 | Improvement of Electron Transport Property and on-Resistance in Normally-OFF Alâ,,Oâ,ƒ/AlGaN/GaN MOS-HEMTs Using Post-Etch Surface Treatment. IEEE Transactions on Electron Devices, 2020, 67, 3541-3547. | 1.6 | 11 |
| 216 | Raman mapping investigations and finite element analysis of double epitaxial lateral overgrown GaN on sapphire substrates. Applied Physics Letters, 2002, 81, 2370-2372. | 1.5 | 10 |

| # | Article | IF | CITATIONS |
|-----|--|-----|-----------|
| 217 | Probing temperature gradients within the GaN buffer layer of AlGaN/GaN high electron mobility transistors with Raman thermography. Journal of Applied Physics, 2014, 115, . | 1.1 | 10 |
| 218 | Electron microscopy of gallium nitride growth on polycrystalline diamond. Semiconductor Science and Technology, 2015, 30, 114007. | 1.0 | 10 |
| 219 | Thermal management of GaN-on-diamond high electron mobility transistors: Effect of the nanostructure in the diamond near nucleation region. , 2016, , . | | 10 |
| 220 | Morphological and electrical comparison of Ti and Ta based ohmic contacts for AlGaN/GaN-on-SiC HFETs. Microelectronics Reliability, 2017, 68, 2-4. | 0.9 | 10 |
| 221 | Evidence of relationship between strain and In-incorporation: Growth of N-polar In-rich InAlN buffer layer by OMCVD. Journal of Applied Physics, 2019, 125, . | 1.1 | 10 |
| 222 | High frequency guided mode resonances in mass-loaded, thin film gallium nitride surface acoustic wave devices. Applied Physics Letters, 2019, 115, . | 1.5 | 10 |
| 223 | Diamond Seed Size and the Impact on Chemical Vapor Deposition Diamond Thin Film Properties. ECS Journal of Solid State Science and Technology, 2020, 9, 053002. | 0.9 | 10 |
| 224 | Electrical and Thermal Performance of Gaâ"Oâ,ƒâ€"Alâ"Oâ,ƒâ€"Diamond Super-Junction Schottky Barrier Diodes. IEEE Transactions on Electron Devices, 2021, 68, 5055-5061. | 1.6 | 10 |
| 225 | Piezo-optics of InP in the visible-ultraviolet range. Physical Review B, 1998, 57, 4432-4442. | 1.1 | 9 |
| 226 | Effects of gate shaping and consequent process changes on AlGaN/GaN HEMT reliability. Physica Status Solidi (A) Applications and Materials Science, 2012, 209, 2646-2652. | 0.8 | 9 |
| 227 | On the discrimination between bulk and surface traps in AlGaN/GaN HEMTs from trapping characteristics. Physica Status Solidi (A) Applications and Materials Science, 2012, 209, 386-389. | 0.8 | 9 |
| 228 | Thermal Transport in Superlattice Castellated Field Effect Transistors. IEEE Electron Device Letters, 2019, 40, 1374-1377. | 2.2 | 9 |
| 229 | Effects of interlayer interactions on the nanoindentation response of freely suspended multilayer gallium telluride. Nanotechnology, 2020, 31, 165706. | 1.3 | 9 |
| 230 | Breakdown Mechanisms in <i>β</i> -Ga ₂ O ₃ Trench-MOS Schottky-Barrier Diodes. IEEE Transactions on Electron Devices, 2022, 69, 75-81. | 1.6 | 9 |
| 231 | Unusual Deformation and Fracture in Gallium Telluride Multilayers. Journal of Physical Chemistry Letters, 2022, 13, 3831-3839. | 2.1 | 9 |
| 232 | Identification of electronic traps in AlGaN/GaN HEMTs using UV light-assisted trapping analysis. , 2010, | | 8 |
| 233 | Field-effect saccharide sensing using AlGaN/GaN heterostructures and boronic acid based chemical receptors. Sensors and Actuators B: Chemical, 2011, 160, 1078-1081. | 4.0 | 8 |
| 234 | GaN transistor reliability and instabilities. , 2014, , . | | 8 |

GaN transistor reliability and instabilities. , 2014, , . 234

| # | Article | IF | CITATIONS |
|-----|---|-----|-----------|
| 235 | 3-D Printed Microjet Impingement Cooling for Thermal Management of Ultrahigh-Power GaN Transistors. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2021, 11, 748-754. | 1.4 | 8 |
| 236 | In situ Thermoreflectance Characterization of Thermal Resistance in Multilayer Electronics Packaging. ACS Applied Electronic Materials, 2022, 4, 1558-1566. | 2.0 | 8 |
| 237 | Gallium nitride phononic integrated circuits platform for GHz frequency acoustic wave devices. Applied Physics Letters, 2022, 120, . | 1.5 | 8 |
| 238 | GaN devices for microwave applications [FET/HEMT]. , 0, , . | | 7 |
| 239 | Effect of Impurities on Raman and Photoluminescence Spectra of AlN Bulk Crystals. Materials Research Society Symposia Proceedings, 2003, 798, 454. | 0.1 | 7 |
| 240 | Behavior of phonons in short period GaN-AlN superlattices. Physica Status Solidi C: Current Topics in Solid State Physics, 2004, 1, 2706-2710. | 0.8 | 7 |
| 241 | Free nucleation of aluminum nitride single crystals in HPBN crucible by sublimation. Materials Science and Engineering B: Solid-State Materials for Advanced Technology, 2005, 117, 99-104. | 1.7 | 7 |
| 242 | Direct optical measurement of hotâ€phonons in active AlGaN/GaN devices. Physica Status Solidi (B): Basic Research, 2008, 245, 910-912. | 0.7 | 7 |
| 243 | GaN Power Transistors with Integrated Thermal Management. ECS Transactions, 2013, 58, 279-286. | 0.3 | 7 |
| 244 | Study of hot electrons in AlGaN/GaN HEMTs under RF Class B and Class J operation using electroluminescence. Microelectronics Reliability, 2015, 55, 2493-2498. | 0.9 | 7 |
| 245 | The Impact of Ti/Al Contacts on AlGaN/GaN HEMT Vertical Leakage and Breakdown. IEEE Electron Device Letters, 2018, 39, 1580-1583. | 2.2 | 7 |
| 246 | Reliability and lifetime estimations of GaN-on-GaN vertical pn diodes. Microelectronics Reliability, 2019, 95, 48-51. | 0.9 | 7 |
| 247 | Impact of thinning the GaN buffer and interface layer on thermal and electrical performance in GaN-on-diamond electronic devices. Applied Physics Express, 2019, 12, 024003. | 1.1 | 7 |
| 248 | Characterization of trap states in buried nitrogen-implanted <i>β</i> -Ga2O3. Applied Physics Letters, 2020, 117, . | 1.5 | 7 |
| 249 | Polarity dependence in Cl2-based plasma etching of GaN, AlGaN and AlN. Applied Surface Science, 2020, 521, 146297. | 3.1 | 7 |
| 250 | Impact of Polymer Residue Level on the In-Plane Thermal Conductivity of Suspended Large-Area Graphene Sheets. ACS Applied Materials & Interfaces, 2021, 13, 17910-17919. | 4.0 | 7 |
| 251 | Multi Phonon Resonant Raman Scattering in GaN/AlxGa1—xN Quantum Wells. Physica Status Solidi (B): Basic Research, 1999, 216, 799-802. | 0.7 | 6 |
| 252 | Resonant Raman scattering in (Al,Ga)N/GaN quantum well structures. Thin Solid Films, 2000, 364, 156-160. | 0.8 | 6 |

| # | Article | IF | CITATIONS |
|-----|--|-----|-----------|
| 253 | High-temperature annealing of AlGaN: Stress, structural, and compositional changes. Journal of Applied Physics, 2003, 94, 6366-6371. | 1.1 | 6 |
| 254 | Raman scattering in InN films and nanostructures. Superlattices and Microstructures, 2004, 36, 581-589. | 1.4 | 6 |
| 255 | Resonant Raman characterization of InAlGaN/GaN heterostructures. Physica Status Solidi (B): Basic Research, 2006, 243, 1674-1678. | 0.7 | 6 |
| 256 | Growth mechanisms and defect structures of B12As2 epilayers grown on 4H-SiC substrates. Journal of Crystal Growth, 2012, 352, 3-8. | 0.7 | 6 |
| 257 | Hot-Electron Electroluminescence Under RF Operation in GaN-HEMTs: A Comparison Among Operational Classes. IEEE Transactions on Electron Devices, 2017, 64, 2155-2160. | 1.6 | 6 |
| 258 | Thermal Profiles Within the Channel of Planar Gunn Diodes Using Micro-Particle Sensors. IEEE Electron Device Letters, 2017, 38, 1325-1327. | 2.2 | 6 |
| 259 | Thermal analysis of semiconductor devices and materials - Why should I not trust a thermal simulation ?. , 2019, , . | | 6 |
| 260 | Time Resolved Hyperspectral Quantum Rod Thermography of Microelectronic Devices: Temperature Transients in a GaN HEMT. IEEE Electron Device Letters, 2020, 41, 812-815. | 2.2 | 6 |
| 261 | Suppression of charge trapping in ON-state operation of AlGaN/GaN HEMTs by Si-rich passivation. Semiconductor Science and Technology, 2021, 36, 095024. | 1.0 | 6 |
| 262 | Vertical field inhomogeneity associated with threading dislocations in GaN high electron mobility transistor epitaxial stacks. Applied Physics Letters, 2021, 119, . | 1.5 | 6 |
| 263 | The Growth of Gallium Nitride Films Produced by Reactive Sputtering at Low Temperature. Physica Status Solidi A, 1999, 176, 319-322. | 1.7 | 5 |
| 264 | The Influence of the Annealing Ambient on Strain and Doping in GaN during High-Temperature Processing. Physica Status Solidi A, 1999, 176, 759-762. | 1.7 | 5 |
| 265 | Characterization of Aluminum Nitride Crystals Grown by Sublimation. Physica Status Solidi A, 2001, 188, 769-774. | 1.7 | 5 |
| 266 | Optimizing GaN-on-Diamond Transistor Geometry for Maximum Output Power. , 2014, , . | | 5 |
| 267 | Thermal properties of AlGaN/GaN high electron mobility transistors on 4H and 6H SiC substrates. Physica Status Solidi (A) Applications and Materials Science, 2014, 211, 2844-2847. | 0.8 | 5 |
| 268 | Solid immersion lenses for enhancing the optical resolution of thermal and electroluminescence mapping of GaN-on-SiC transistors. Journal of Applied Physics, 2015, 118, . | 1.1 | 5 |
| 269 | Subthreshold Mobility in AlGaN/GaN HEMTs. IEEE Transactions on Electron Devices, 2016, 63, 1861-1865. | 1.6 | 5 |
| 270 | Lateral Charge Distribution and Recovery of Dynamic <inline-formula> <tex-math notation="LaTeX">\$R_{mathrm{scriptscriptstyle ON}} </tex-math </inline-formula> in AlGaN/GaN HEMTs. IEEE Transactions on Electron Devices, 2018, 65, 4462-4468. | 1.6 | 5 |

| # | Article | IF | CITATIONS |
|-----|---|-----|-----------|
| 271 | Noise Analysis of the Leakage Current in Time-Dependent Dielectric Breakdown in a GaN SLCFET. IEEE Transactions on Electron Devices, 2021, 68, 2220-2225. | 1.6 | 5 |
| 272 | Stress at the Coalescence Boundary of Epitaxial Lateral Overgrown GaN. Physica Status Solidi A, 2001, 188, 747-750. | 1.7 | 4 |
| 273 | Raman scattering, photoluminescence, and X-ray diffraction studies of GaN layers grown on misoriented sapphire substrates. Materials Science and Engineering B: Solid-State Materials for Advanced Technology, 2002, 93, 15-18. | 1.7 | 4 |
| 274 | Investigation of Thin Film Growth of B ₁₂ As ₂ by Chemical Vapor Deposition. Materials Research Society Symposia Proceedings, 2003, 764, 1. | 0.1 | 4 |
| 275 | Raman-IR micro-thermography tool for reliability and failure analysis of electronic devices. , 2008, , . | | 4 |
| 276 | Mechanism for Improved Quality B12As2 Epitaxial Films on (0001) 4H-SiC Substrates by Tilting toward [1-100] Direction. Materials Research Society Symposia Proceedings, 2010, 1246, 1. | 0.1 | 4 |
| 277 | Electronic excitations in B12As2and their temperature dependence by vacuum ultraviolet ellipsometry. Journal of Physics Condensed Matter, 2010, 22, 395801. | 0.7 | 4 |
| 278 | Lateral charge spreading and device-to-device coupling in C-doped AlGaN/GaN-on-Si wafers. Microelectronics Reliability, 2019, 95, 81-86. | 0.9 | 4 |
| 279 | Correlating Thermionic Emission with Specific Surface Reconstructions in a <100> Hydrogenated Single-Crystal Diamond. ACS Applied Materials & Interfaces, 2020, 12, 26534-26542. | 4.0 | 4 |
| 280 | Evaluating the interfacial toughness of GaN-on-diamond with an improved analysis using nanoindentation. Scripta Materialia, 2022, 209, 114370. | 2.6 | 4 |
| 281 | A trapping tolerant drain current based temperature measurement of <i>l²</i> -Ga ₂ O ₃ MOSFETs. Applied Physics Letters, 2022, 120, 073502. | 1.5 | 4 |
| 282 | Edge termination in vertical GaN diodes: Electric field distribution probed by second harmonic generation. Applied Physics Letters, 2022, 120, . | 1.5 | 4 |
| 283 | GaN-on-diamond materials and device technology: A review. , 2022, , 295-331. | | 4 |
| 284 | First-order resonant Raman scattering under an electric field. Physical Review B, 1996, 54, 11492-11504. | 1.1 | 3 |
| 285 | Micro-Raman Spectroscopy: Self-Heating Effects In Deep UV Light Emitting Diodes. Materials Research Society Symposia Proceedings, 2002, 743, L7.8.1. | 0.1 | 3 |
| 286 | Sublimation Growth of Aluminum Nitride-Silicon Carbide Alloy Crystals on SiC (0001) Substrates. Materials Research Society Symposia Proceedings, 2004, 831, 347. | 0.1 | 3 |
| 287 | Flip Chip Mounting for Improved Thermal Management of AlGaN/GaN HFETs. Materials Research Society Symposia Proceedings, 2005, 892, 352. | 0.1 | 3 |
| 288 | Reliability optimization for wide bandgap devices: Recent developments in high-spatial resolution thermal imaging of GaN devices. , 0, , . | | 3 |

| # | Article | IF | CITATIONS |
|-----|---|-----|-----------|
| 289 | Microâ€Raman analysis of GaAs Schottky barrier solar cell. Journal of Raman Spectroscopy, 2011, 42, 422-428. | 1.2 | 3 |
| 290 | Elimination of Degenerate Epitaxy in the Growth of High Quality B12As2 Single Crystalline Epitaxial Films. Materials Research Society Symposia Proceedings, 2011, 1307, 1. | 0.1 | 3 |
| 291 | Improved GaN-on-SiC Transistor Thermal Resistance by Systematic Nucleation Layer Growth Optimization. , 2013, , . | | 3 |
| 292 | Improvements in thermionic cooling through engineering of the heterostructure interface using Monte Carlo simulations. Journal of Applied Physics, 2013, 114, . | 1.1 | 3 |
| 293 | Liquid crystal electrography: Electric field mapping and detection of peak electric field strength in AlGaN/GaN high electron mobility transistors. Microelectronics Reliability, 2014, 54, 921-925. | 0.9 | 3 |
| 294 | Ohmic Contact-Free Mobility Measurement in Ultra-Wide Bandgap AlGaN/AlGaN Devices. IEEE Electron Device Letters, 2018, 39, 55-58. | 2.2 | 3 |
| 295 | Field Plate Designs in All-GaN Cascode Heterojunction Field-Effect Transistors. IEEE Transactions on Electron Devices, 2019, 66, 1688-1693. | 1.6 | 3 |
| 296 | High Efficiency AlN/GaN HEMTs for Q-Band Applications with an Improved Thermal Dissipation. International Journal of High Speed Electronics and Systems, 2019, 28, 1940003. | 0.3 | 3 |
| 297 | UV-induced change in channel conductivity in AlGaN/GaN high electron mobility transistors to measure doping. Applied Physics Letters, 2021, 118, . | 1.5 | 3 |
| 298 | SnTeâ€doping of GaAs grown by atomic layer molecular beam epitaxy. Journal of Applied Physics, 1995, 77, 4339-4342. | 1.1 | 2 |
| 299 | Thermal Stability of GaN Investigated by Raman Scattering. MRS Internet Journal of Nitride Semiconductor Research, 1999, 4, 653-658. | 1.0 | 2 |
| 300 | On Phonon Confinement Effects and Free Carrier Concentration in GaN Quantum Dots. Physica Status Solidi (B): Basic Research, 2001, 228, 195-198. | 0.7 | 2 |
| 301 | Thermal management and device failure assessment of high-power AlGaN/GaN HFETs. , 0, , . | | 2 |
| 302 | High Temperature Annealing of AlGaN: Stress and Composition Changes. Physica Status Solidi C: Current Topics in Solid State Physics, 2003, 0, 568-571. | 0.8 | 2 |
| 303 | Time-resolved nanosecond sub-micron resolution thermal analysis of high-power AlGaN/GaN HFETs. Physica Status Solidi (A) Applications and Materials Science, 2007, 204, 2014-2018. | 0.8 | 2 |
| 304 | An investigation of phonon decay in B12As2 by Raman scattering spectroscopy. Journal of Applied Physics, 2008, 103, . | 1.1 | 2 |
| 305 | Impact of the field induced polarization space-charge on the characteristics of AlGaN/GaN HEMT: Self-consistent simulation study. Physica Status Solidi C: Current Topics in Solid State Physics, 2009, 6, S1007-S1011. | 0.8 | 2 |
| 306 | Silver diamond composite as a new packaging solution: A thermo-mechanical stability study. , 2011, , . | | 2 |

| # | Article | IF | CITATIONS |
|-----|---|------|-----------|
| 307 | Analysis of strained surface layers of ZnO single crystals after irradiation with intense femtosecond laser pulses. Applied Physics Letters, 2013, 102, . | 1.5 | 2 |
| 308 | Multi-channel power transistors shape up. Nature Electronics, 2019, 2, 553-554. | 13.1 | 2 |
| 309 | A systematic study of MOCVD reactor conditions and Ga memory effect on properties of thick InAl(Ga)N layers: a complete depth-resolved investigation. CrystEngComm, 2020, 22, 130-141. | 1.3 | 2 |
| 310 | Current collapse and kink effect in GaN RF HEMTs: the key role of the epitaxial buffer. , 2020, , . | | 2 |
| 311 | Focused Ion Beam Etching of GaN. MRS Internet Journal of Nitride Semiconductor Research, 1999, 4, 769-774. | 1.0 | 2 |
| 312 | Focused Ion Beam Etching of Nanometer-Size GaN/AlGaN Device Structures and their Optical Characterization by Micro-Photoluminescence/Raman Mapping. MRS Internet Journal of Nitride Semiconductor Research, 2000, 5, 950-956. | 1.0 | 2 |
| 313 | Study of Drain Injected Breakdown Mechanisms in AlGaN/GaN-on-SiC HEMTs. IEEE Transactions on Electron Devices, 2022, 69, 525-530. | 1.6 | 2 |
| 314 | Thermal characterization of direct wafer bonded Si-on-SiC. Applied Physics Letters, 2022, 120, 113503. | 1.5 | 2 |
| 315 | Focused ION Beam Etching of GaN. Materials Research Society Symposia Proceedings, 1998, 537, 1. | 0.1 | 1 |
| 316 | Deep Ultraviolet Raman Scattering for the Monitoring of High-Temperature Processing of AlGaN. Physica Status Solidi (B): Basic Research, 1999, 215, 105-108. | 0.7 | 1 |
| 317 | The Use of Micro-Raman Spectroscopy to Monitor High-Pressure High-Temperature Annealing of Ion-Implanted GaN Films. Materials Research Society Symposia Proceedings, 1999, 595, 1. | 0.1 | 1 |
| 318 | Self-Heating Effects in High-Power AlGaN/GaN HFETs. Materials Research Society Symposia Proceedings, 2001, 693, 271. | 0.1 | 1 |
| 319 | Determination of the Mode Grüneisen Parameter of AlN using different Fits on Experimental High Pressure Data. High Pressure Research, 2002, 22, 37-41. | 0.4 | 1 |
| 320 | Self-Heating Effects in Multi-Finger AlGaN/GaN HFETs. Materials Research Society Symposia Proceedings, 2002, 743, L9.7.1. | 0.1 | 1 |
| 321 | Growth of Rhombohedral B12P2 Thin Films on 6H-SiC(0001) By Chemical Vapor Deposition. Materials Research Society Symposia Proceedings, 2003, 799, 63. | 0.1 | 1 |
| 322 | Raman spectroscopic studies of vibrational relaxation and non oincidence effect in substituted benzaldehyde binary mixtures. Journal of Raman Spectroscopy, 2010, 41, 320-324. | 1.2 | 1 |
| 323 | Micro-Raman spectroscopy as a voltage probe in AlGaN/GaN heterostructure devices: Determination of buffer resistances. Solid-State Electronics, 2011, 55, 5-7. | 0.8 | 1 |
| 324 | Early stage degradation of InAlN/GaN HEMTs during electrical stress. , 2012, , . | | 1 |

| # | Article | IF | CITATIONS |
|-----|--|-----|-----------|
| 325 | On wafer thermal characterization of miniature gallium arsenide microcoolers with thermal loading from DC probes. Microwave and Optical Technology Letters, 2014, 56, 2699-2700. | 0.9 | 1 |
| 326 | Micro-cooler enhancements by barrier interface analysis. AIP Advances, 2014, 4, 027105. | 0.6 | 1 |
| 327 | Simultaneous measurement of optical and RF behavior under CW and pulsed Fully Active Harmonic Load-Pull. , 2016, , . | | 1 |
| 328 | Transient thermoreflectance wafer mapping for process control and development: GaN-on-Diamond. , 2017, , . | | 1 |
| 329 | Raman Scattering in GaN/AlN Quantum Dot Structures. , 1999, 216, 457. | | 1 |
| 330 | Nano-Fabrication of GaN Pillars Using Focused Ion Beam Etching. , 1999, 176, 355. | | 1 |
| 331 | Reliability Assessment of a New Power Electronics Packaging Material: Silver Diamond Composite. Journal of Microelectronics and Electronic Packaging, 2013, 10, 54-58. | 0.8 | 1 |
| 332 | High Efficiency AlN/GaN HEMTs for Q-Band Applications with an Improved Thermal Dissipation. Selected Topics in Electornics and Systems, 2020, , 51-62. | 0.2 | 1 |
| 333 | Heat Transport across Interfaces for the Optimization of Heat Sinking in Device Applications. , 2021, , . | | 1 |
| 334 | Ga ₂ O ₃ – diamond for next generation power electronics. , 2022, , . | | 1 |
| 335 | Thermal Stability of GaN Investigated by Raman Scattering. Materials Research Society Symposia Proceedings, 1998, 537, 1. | 0.1 | 0 |
| 336 | A Study of Annealed GaN Grown by Molecular Beam Epitaxy Using Photoluminescence Spectroscopy Materials Research Society Symposia Proceedings, 1999, 595, 1. | 0.1 | 0 |
| 337 | Focused Ion Beam Etching of Nanometer-Size GaN/AlGaN Device Structures and their Optical Characterization by Micro-Photoluminescence/Raman Mapping. Materials Research Society Symposia Proceedings, 1999, 595, 1. | 0.1 | 0 |
| 338 | Phonon Lifetimes and Phonon Decay Channels in Single Crystalline Bulk Aluminum Nitride. Materials Research Society Symposia Proceedings, 2000, 639, 771. | 0.1 | 0 |
| 339 | Raman Mapping and Finite Element Analysis of Epitaxial Lateral Overgrown GaN on Sapphire Substrates. Materials Research Society Symposia Proceedings, 2002, 743, L3.12.1. | 0.1 | 0 |
| 340 | Gallium nitride based ballistic electron acceleration negativedifferentialconductivity diodes for potential THZ applications. , 2005, , . | | 0 |
| 341 | Characterization and Growth Mechanism of B12As2 Epitaxial Layers Grown on (1-100) 15R-SiC. Materials Research Society Symposia Proceedings, 2008, 1069, 1. | 0.1 | 0 |
| 342 | Origins of Twinned Microstructures in B12As2 Epilayers Grown on (0001) 6H-SiC and Their Influence on Physical Properties. Materials Research Society Symposia Proceedings, 2009, 1164, 1. | 0.1 | 0 |

| # | Article | IF | CITATIONS |
|-----|--|-----|-----------|
| 343 | Growth of Boron Carbide Crystals from a Copper Flux. Materials Research Society Symposia Proceedings, 2009, 1164, 1. | 0.1 | 0 |
| 344 | Solution Growth and Characterization of Icosahedral Boron Arsenide (B12As2). Materials Research Society Symposia Proceedings, 2011, 1307, 1. | 0.1 | 0 |
| 345 | Junction temperature measurements and reliability of GaN FETs. , 2013, , . | | 0 |
| 346 | Non-invasive Thermal Resistance Measurement for GaN Wafer Process Control and Optimization. , 2018, , . | | 0 |
| 347 | The Use of Micro-Raman Spectroscopy to Monitor High-Pressure High Temperature Annealing of Ion-Implanted GaN Films. MRS Internet Journal of Nitride Semiconductor Research, 2000, 5, 740-746. | 1.0 | 0 |
| 348 | A study of annealed GaN grown by molecular beam epitaxy using photoluminescence spectroscopy MRS Internet Journal of Nitride Semiconductor Research, 2000, 5, 761-767. | 1.0 | 0 |
| 349 | Nitride-Based Light Emitting Diodes and Laser Diodes: Optical Properties and Applications. Springer Series in Solid-state Sciences, 2004, , 289-320. | 0.3 | Ο |
| 350 | Thermal characteristics of superlattice castellated FETs. , 2022, , 223-230. | | 0 |